

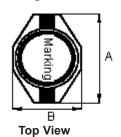
MCBFS5220-3R3MU

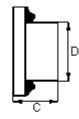
	REVISIONS							·
ECN #	REV	DESCRIPTION	DRAWN	DATE	CHECKD	DATE	APPRVD	DATE
-	Α	RELEASED	ASH	20/4/11	SID	20/4/11		04/5/11

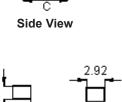
RoHS

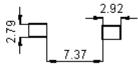
Compliant

Configurations and Dimensions









Suggest PCB Layout

Dimensions: Millimetres

Marking: 3R3

Bottom View

Electrical Characteristics (at 25°C)

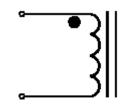
Test Condition		
100 KHz 0.1 V	L	3.3 µH ±20%
at 25°C	DCR	36 mΩ (Max.)
100 KHz 0.1 V I _{rms} = 4.87 A	L at I _{rms}	ΔT 40°C (Max.)

Operating temperature : -55°C to +130°C

Note: I_{rms}: Temperature rise 40°C

12.95 mm		
9.5 mm	(Max.)	
5.2 mm		
8.4 ±0.3 mm	-	
7.62 mm		
2.54 mm	(Ref.)	
2.54 11111		
	9.5 mm 5.2 mm 8.4 ±0.3 mm	

Schematic Diagram





- 1. Wire Ø0.33mm × 1P 2UEWF 155°C
- 2. 11.5TS (Reference)

Test Data for Mechanical

Test Item	A mm	B mm	C mm	D mm	E mm	F mm	G mm
Specification	12.95 (Max.)	9.5 (Max.)	5.2 (Max.)	8.4 ±0.3	7.62 (Ref.)	2.54 (Ref.)	2.54 (Ref.)
1	12.75	9.21	4.78	8.5	7.62	2.52	2.53
2	12.73	9.22	4.8	8.48	7.6	2.51	2.52
3	12.78	9.2	4.81	8.51	7.61	2.53	2.53
4	12.8	9.18	4.8	8.52	7.62	2.5	2.51
5	12.74	9.2	4.79	8.49	7.59	2.52	2.52
Average	12.76	9.2	4.8	8.5	7.61	2.52	2.52

UNLESS OTHERWISE
SPECIFIED,
DIMENSIONS ARE
FOR REFERENCE
UNLESS OTHERWISE SPECIFIED, DIMENSIONS ARE FOR REFERENCE PURPOSES ONLY.

TOLERANCES:

DRAWN BY:	DATE:
ARU	20/04/11
CHECKED BY:	DATE:
SID	20/04/11
APPROVED BY:	DATE:
	04/05/11

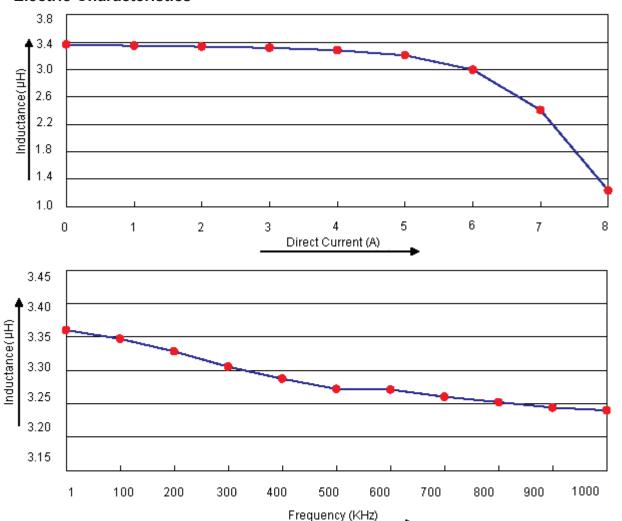
:	DRAWING TITLE:						
	Inductor						
:_	SIZE	DWG NO.	M10003211	ELECTRONIC FILE RI MCBFS5220-3R3MU A			
:	Α		I	IVICE	DF3022U-3H3IVIU	L A	
	SCAL	E: NTS	U.O.M.: mm		SHEET: 1 O	F 4	



MCBFS5220-3R3MU

REVISIONS								
ECN #	REV	DESCRIPTION	DRAWN	DATE	CHECKD	DATE	APPRVD	DATE
-	Α	RELEASED	ASH	20/4/11	SID	20/4/11		04/5/11





Test Data for Electrical

Test Item	L µH	DCR mΩ	L at I _{rms} μΗ
Condition	100 KHz 0.1 V	at 25°C	100 KHz 0.1 V I _{rms} = 4.87 A
Specification	3.3 ±20%	36 (Max.)	ΔT 40°C (Max.)
1	3.33	30.52	
2	3.39	30.8	
3	3.35	29.86	ОК
4	3.32	29.58	
5	3.21	30.24	
Average	3.32	30.2	ОК

Important Notice: This data sheet and its contents (the "Information") belong to the members of the Premier Farnell group of companies (the "Group") or are licensed to it. No licence is granted for the use of it other than for information purposes in connection with the products to which it relates. No licence of any intellectual property rights is granted. The Information subject to change without notice and replaces all data sheets previously supplied. The Information supplied is believed to be accurate but the Group assumes no responsibility for its accuracy or completeness, any error in or omission from it or for any use made of it. Users of this data sheet should check for themselves the Information and the suitability of the products for their purpose and not make any assumptions based on information included or omitted. Liability for loss or damage resulting from any reliance on the Information or use of it (including liability resulting from negligence or where the Group was aware of the possibility of such loss or damage arising) is excluded. This will not operate to limit or restrict the Group's liability for death or personal injury resulting from its negligence. Multicomp is the registered trademark of the Group. © Premier Farnell ptz 2011.

UNLESS OTHERWISE SPECIFIED, DIMENSIONS ARE FOR REFERENCE PURPOSES ONLY.

TOLERANCES:

DRAW	N BY:	DATE:
ARU		20/04/11
CHEC	KED BY:	DATE:
SID		20/04/11
APPR	OVED BY:	DATE:
		04/05/11

DRAWI	NG TITLE:					
		Inductor				
SIZE A	DWG NO.	M10003211		ELECTRONIC FILE MCBFS5220-3R3MU		
SCALE: NTS		U.O.M.: mm		SHEET:	2 01	= 4



MCBFS5220-3R3MU

		REVISIONS						
ECN #	ECN # REV DESCRIPTION		DRAWN	DATE	CHECKD	DATE	APPRVD	DATE
-	Α	RELEASED	ASH	20/4/11	SID	20/4/11		04/5/11

Reliability Test

Test Item	Specifications	Test Method and Remarks			
Solderability	The electrodes shall be at least 90% covered with new solder coating.	According to IEC68-2-20 Soldering temperature : 245 ±5°C Solder : Sn99.3% / Cu0.7% Flux : Rosin Immersion time : 5 ±1 s			
Soldering heat resistance	Appearance : No damage Inductance change : Within ±10% of initial value	Preheat temperature 150°C Preheat time : 1 min Solder temperature : 260 ±5°C Dipping time : 10 ±1 s Measured at room temperature after placing for 24 hours.			
Vibration (Out LAB)	Appearance : No damage All electrical and mechanical parameters within tolerance.	According to MIL-STD202 Method 204 Frequency : 10 to 55 Hz Amplitude : 1.52 mm Direction and time X Y and Z direction for 2 hours each.			
Humidity Appearance : No damage resistance test All electrical and mechanical parameters within tolerance.		According to IEC68-2-1 Method Ca Temperature : 40 ±2°C Humidity : 90%-95% RH Test time : 500 ±2 hrs The component should be stabilized at normal condition for 24 hours before test.			
High temperature resistance test	Appearance : No damage All electrical and mechanical parameters within tolerance.	According to IEC68-2-2 Temperature : 85 ±3°C Test time : 500 +24 hrs The component should be stabilized at normal condition for 24 hours before test.			
Low temperature resistance test	Appearance : No damage All electrical and mechanical parameters within tolerance.	According to IEC68-2-1 Method A (Ad) Temperature : -40 ±3°C Test time : 500 +24 hrs The component should be stabilized at normal condition for 24 hours before test.			
Temperature cycles test	Appearance : No damage All electrical and mechanical parameters within tolerance.	According to IEC68-2-14 Method N (Nb) High-temperature : 85 ±3°C duration 30 mins Room-temperature : 25 ±2°C duration 3 hrs Low-temperature : -40 ±3°C duration 30 mins Room-temperature : 25 ±2°C duration 3 hrs Number of cycle : 10 cycles The component should be stabilized at normal condition for 24 hours before test.			

Important Notice: This data sheet and its contents (the "Information") belong to the members of the Premier Farnell group of companies (the "Group") or are licensed to it. No licence is granted for the use of it other than for information purposes in connection with the products to which it relates. No licence of any intellectual property rights is granted. The Information subject to change without notice and replaces all data sheets previously supplied. The Information supplied is believed to be accurate but the Group assumes no responsibility for its accuracy or completeness, any error in or omission from it or for any use made of it. Users of this data sheet should check for themselves the Information and the suitability of the products for their purpose and not make any assumptions based on information included or omitted. Liability for loss or damage resulting from any reliance on the Information or use of it (including liability resulting from negligence or where the Group was aware of the possibility of such loss or damage arising) is excluded. This will not operate to limit or restrict the Group's liability for death or personal injury resulting from its negligence. Multicomp is the registered trademark of the Group. © Premier Farnell plc 2011.

UNLESS OTHERWISE SPECIFIED, DIMENSIONS ARE FOR REFERENCE PURPOSES ONLY.

TOLERANCES:

DRAWN BY:	DATE:
ARU	20/04/11
CHECKED BY:	DATE:
SID	20/04/11
APPROVED BY:	DATE:
	04/05/11

:	DRAWING TITLE:								
I	Inductor								
:	SIZE DWG NO. A SCALE: NTS			M10003211		ELECTRONIC FILE			
:					MCBFS5220-3R3MU				
<u>. </u>				U.O.M.: mm		SHEET:	3 O	F 4	



MCBFS5220-3R3MU

REVISIONS								
ECN # REV DESCRIPTION		DRAWN	DATE	CHECKD	DATE	APPRVD	DATE	
-	A RELEASED		ASH	20/4/11	SID	20/4/11		04/5/11

Material List

No.	ltem	Material Description		
1	Core	R5A DR4.8 × 4 R5A RI 8.4 × 4.1 × 6.85		
2	Wire	Ø0.33 mm × 1P 2UEWF (155°C)		
3	Solder (Lead-free)	Sn99.3% / Cu0.7%		
4	Glue	TH320D / TH320-3		
5 Base		SN-BS019.01 LCP		

Part Number Table

Description	Part Number			
Inductor, 3.3µH, 20%, 4.5A	MCBFS5220-3R3MU			

http://www.element14.com

http://www.farnell.com

http://www.newark.com

Important Notice: This data sheet and its contents (the "Information") belong to the members of the Premier Farnell group of companies (the "Group") or are licensed to it. No licence is granted for the use of it other than for information purposes in connection with the products to which it relates. No licence of any intellectual property rights is granted. The Information subject to change without notice and replaces all data sheets previously supplied. The Information supplied is believed to be accurate but the Group assumes no responsibility for its accuracy or completeness, any error in or omission from it or for any use made of it. Users of this data sheet should check for themselves the Information and the suitability of the products for their purpose and not make any assumptions based on information included or omitted. Liability for loss or damage resulting from any reliance on the Information or use of it (including liability resulting from negligence or where the Group was aware of the possibility of such loss or damage arising) is excluded. This will not operate to limit or restrict the Group's liability for death or personal injury resulting from its negligence. Multicomp is the registered trademark of the Group. © Premier Farnell plc 2011.

TOLERANCES:

UNLESS OTHERWISE SPECIFIED,
DIMENSIONS ARE FOR REFERENCE PURPOSES ONLY.

DRAWN BY:	DATE:
ARU	20/04/11
CHECKED BY:	DATE:
SID	20/04/11
APPROVED BY:	DATE:
	04/05/11

DRAWI	NG TITLE:					
		Induct	or			
SIZE A	DWG NO.	M10003211	l -	TRONIC FII 3FS5220-3	NIC FILE 3220-3R3MU	
 SCAL	E: NTS	U.O.M.: mm		SHEET:	4 0	= 4